

# **AW-CM276NF**

## **IEEE 802.11a/b/g/n/ac Wireless LAN 2T2R and Bluetooth 5.3 Combo Module (M.2 1216)**

### **Datasheet**

**Rev. L**

**0B**

**(For Standard)**

## Features

### Wi-Fi

- PCIe M.2 TYPE 1216: 16mm(L) x 12mm(W) x 1.85 mm(H)(Max), 130pins LGA package
- SDIO 3.0 or PCIe interfaces support for WLAN
- Sub-meter accuracy WiFi indoor locationing(802.11mc)
- Multiple power saving modes for low power consumption
- IEEE 802.11i for advanced security
- Quality of Service (QoS) support for multimedia applications
- Support China WAPI
- Lead-free design

### Bluetooth

- UART interfaces support for Bluetooth
- High speed UART,PCM interfaces
- Audio Codec interface support
- Bluetooth 5.3 compliant with Bluetooth 2.1 + Enhanced Data Rate (EDR)

## Revision History

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Version	Revision Date	DCN NO.	Description	Initials	Approved
A	2019/10/23	DCN016172	● Initial Version(new format)	Renton Tao	NC Chen
B	2020/02/05	DCN016708	● Add configuration table for Host interface	Renton Tao	NC Chen
C	2020/06/16	DCN017530	● Remove watermark ● Correct typo	Renton Tao	NC Chen
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F	2021/04/08	DCN021289	● Add pin numbers description ● Change to new format ● Update chipset vendor to NXP	Renton Tao	NC Chen
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K	2023/09/06	DCN030019	● Update Mechanical Drawing	Roger Liu	NC Chen
L	2023/12/07	DCN030641	● Remove SDIO/SDIO Interface	Grace Yang	NC Chen

## Table of Contents

Revision History.....	3
Table of Contents.....	4
<b>1. Introduction .....</b>	<b>5</b>
<b>1.1 Product Overview .....</b>	<b>5</b>
<b>1.2 Block Diagram.....</b>	<b>6</b>
<b>1.3 Specifications Table .....</b>	<b>7</b>
1.3.1 General .....	7
1.3.2 WLAN .....	7
1.3.3 Bluetooth.....	9
1.3.4 Operating Conditions.....	10
<b>2. Pin Definition.....</b>	<b>11</b>
<b>2.1 Pin map.....</b>	<b>11</b>
<b>2.2 Pin Table.....</b>	<b>12</b>
<b>3. Electrical Characteristics .....</b>	<b>15</b>
<b>3.1 Absolute Maximum Ratings .....</b>	<b>15</b>
<b>3.2 Recommended Operating Conditions .....</b>	<b>15</b>
<b>3.3 Digital IO Pin DC Characteristics.....</b>	<b>16</b>
3.3.1 DC Electricals-1.8V Operation (VIO) .....	16
3.3.2 3.3V Operation (VIO).....	16
3.3.3 1.8V Operation (VIO_SD).....	16
3.3.4 3.3V Operation (VIO_SD).....	16
<b>3.4 Host Interface.....</b>	<b>17</b>
3.4.1 SDIO Interface .....	17
3.4.2 PCI Express Interface .....	22
3.4.3 High-Speed UART Interface.....	23
3.4.4 PCM Interface .....	25
<b>3.5. Power up Timing Sequence .....</b>	<b>28</b>
<b>3.6 Power Consumption .....</b>	<b>29</b>
3.6.1 WLAN .....	29
3.6.2 Bluetooth.....	29
<b>4. Mechanical Information .....</b>	<b>30</b>
<b>4.1 Mechanical Drawing .....</b>	<b>30</b>
<b>4.2 Pin out drawing.....</b>	<b>31</b>
<b>4.3 Antenna connector drawing.....</b>	<b>32</b>
<b>5. Packaging Information .....</b>	<b>33</b>

## 1. Introduction

### 1.1 Product Overview

**AzureWave Technologies, Inc.** introduces the IEEE 802.11ac/a/b/g/n 2X2 MU-MIMO WLAN & Bluetooth NGFF module --- **AW-CM276NF**. The module is targeted to mobile devices including **Notebook, TV, Tablet and Gaming Device** which need small package module, low power consumption, multiple interfaces and OS support. By using AW-CM276NF, the customers can easily enable the Wi-Fi, and BT embedded applications with the benefits of **high design flexibility, short development cycle, and quick time-to-market**.

Compliance with the IEEE 802.11ac/a/b/g/n standard supporting 802.11ac Wave 2, the AW-CM276NF uses Direct Sequence Spread Spectrum (**DSSS**), Orthogonal Frequency Division Multiplexing (**OFDM**), **DBPSK, DQPSK, CCK** and **QAM** baseband modulation technologies. A high level of integration and full implementation of the power management functions specified in the IEEE 802.11 standard minimize the system power requirements by using AW-CM276NF. In addition to the support of **WPA/WPA2/WPA3** and **WEP** 64-bit and 128-bit encryption, the AW-CM276NF also supports the **IEEE 802.11i** security standard through the implementation of **Advanced Encryption Standard (AES)/Counter Mode CBC-MAC Protocol (CCMP)**, Wired Equivalent Privacy (**WEP**) with Temporal Key Integrity Protocol (**TKIP**), Advanced Encryption Standard (**AES**)/Cipher-Based Message Authentication Code (**CMAC**), and WLAN Authentication and Privacy Infrastructure (**WAPI**) security mechanisms.

For the video, voice and multimedia applications the AW-CM276NF support **802.11e Quality of Service (QoS)**. The device also supports **802.11h Dynamic Frequency Selection (DFS)** for detecting radar pulses when operating in the 5GHz range.

For Bluetooth operation, AW-CM276NF is **Bluetooth 5.3 (supports Low Energy)**.

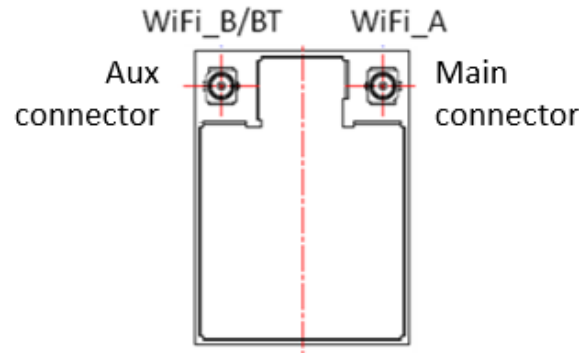
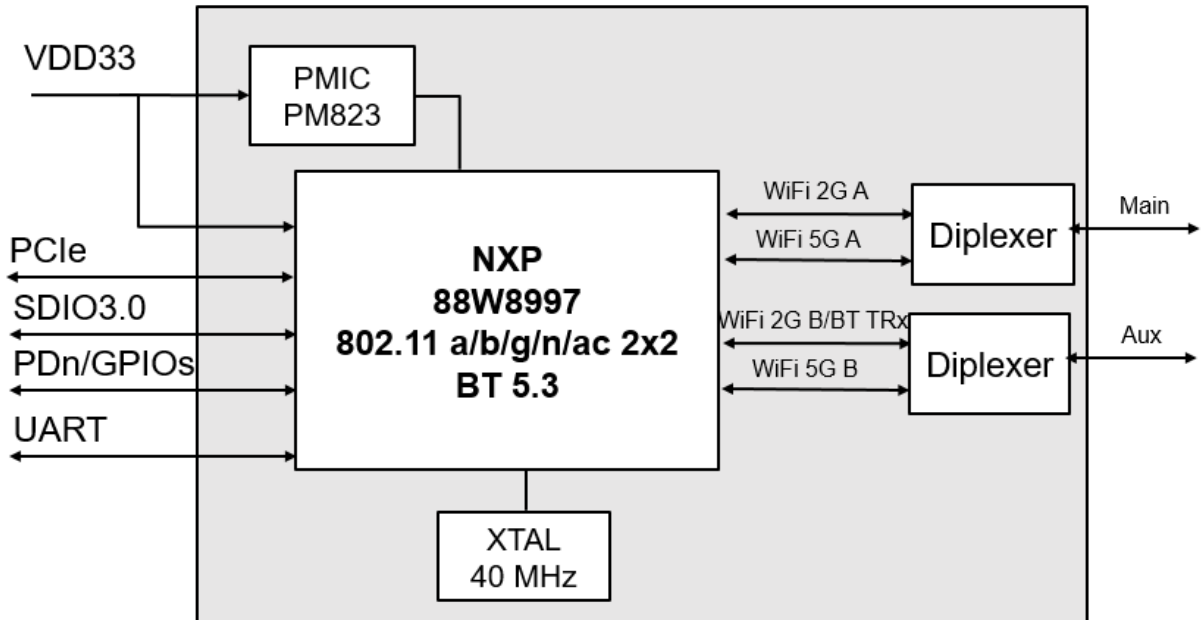
**AW-CM276NF** supports **PCIE and SDIO3.0** for WLAN and high speed **UART interfaces** for Bluetooth to the host processor.

**AW-CM276NF** is suitable for multiple mobile processors for different applications with the support cellular phone co-existence.

**AW-CM276NF** module adopts NXP's latest highly-integrated dual-band WLAN & Bluetooth SoC--- **88W8997**. All the other components are implemented by all means to reach the mechanical specification required.

## 1.2 Block Diagram

### AW-CM276NF NGFF Module



**Module antenna configuration**

## 1.3 Specifications Table

### 1.3.1 General

Features	Description
<b>Product Description</b>	IEEE 802.11 2X2 WiFi 5 MIMO Wireless LAN + Bluetooth 5.3 Combo LGA Module
<b>Major Chipset</b>	NXP 88W8997
<b>Host Interface</b>	Wi-Fi + BT <ul style="list-style-type: none"> <li>● PCIe + UART</li> <li>● SDIO3.0 + UART</li> </ul> (For Host configuration interface, please refer to section 2.3)
<b>Dimension</b>	12 mm x 16 mm x 1.85 mm(Max) (Tolerance remarked in mechanical drawing)
<b>Form factor</b>	M.2 1216 130pins LGA package
<b>Antenna</b>	I-PEX MHF4 Connector Receptacle (20449) Main : Wi-Fi → TX/RX Aux : Wi-Fi / Bluetooth → TX/RX
<b>Weight</b>	0.5 g

### 1.3.2 WLAN

Features	Description
WLAN Standard	IEEE 802.11 a/b/g/n/ac
WLAN VID/PID	1B4B/2B42
<b>WLAN SVID/SPID</b>	N/A
Frequency Range	2.4 GHz : 2.412 ~ 2.484 GHz 5 GHz : 5.18 ~5.825GHz
Modulation	DSSS, OFDM, DBPSK, DQPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Number of Channels	<b>2.4GHz</b> <ul style="list-style-type: none"> <li>■ USA, NORTH AMERICA, Canada and Taiwan – 1 ~ 11</li> <li>■ China, Australia, Most European Countries, Japan – 1 ~ 13</li> </ul> <b>5GHz</b> <ul style="list-style-type: none"> <li>■ USA, EUROPE – 36, 40, 44, 48, 52, 56, 60, 64, 100, 104, 108, 112, 116, 120, 124, 128, 132, 136, 140, 149, 153, 157, 161, 165</li> </ul>

Output Power (Board Level Limit)*	<b>2.4GHz</b>				
		Min	Typ	Max	Unit
	11b (11Mbps) @EVM<35%	15.5	17	18.5	dBm
	11g (54Mbps) @EVM $\leq$ -27 dB	14.5	16	17.5	dBm
	11n (HT20 MCS7) @EVM $\leq$ -28 dB	14.5	16	17.5	dBm
	11n (HT40 MCS7) @EVM $\leq$ -28 dB	12.5	14	15.5	dBm
	<b>5GHz</b>				
		Min	Typ	Max	Unit
	11a (54Mbps) @EVM $\leq$ -27 dB	11	13	15	dBm
	11n (HT20 MCS7) @EVM $\leq$ -28 dB	11	13	15	dBm
	11n (HT40 MCS7) @EVM $\leq$ -28 dB	10	12	14	dBm
	11ac (VHT20 MCS8) @EVM $\leq$ -30 dB	11	13	15	dBm
	11ac (VHT40 MCS9) @EVM $\leq$ -32 dB	10	12	14	dBm
	11ac (VHT80 MCS9) @EVM $\leq$ -32 dB	8	10	12	dBm
Receiver Sensitivity	<b>2.4GHz</b>				
		Min	Typ	Max	Unit
	11b (11Mbps)		-88	-85	dBm
	11g (54Mbps)		-75	-72	dBm
	11n (HT20 MCS7)		-72	-70	dBm
	11n (HT40 MCS7)		-69	-67	dBm
	<b>5GHz</b>				
		Min	Typ	Max	Unit
	11a (54Mbps)		-72	-68	dBm
	11n (HT20 MCS7)		-70	-67	dBm
	11n (HT40 MCS7)		-68	-65	dBm
	11ac(VHT20 MCS8)		-65	-62	dBm
	11ac(VHT40 MCS9)		-63	-60	dBm
	11ac(VHT80 MCS9)		-60	-57	dBm
Data Rate	<ul style="list-style-type: none"> <li>■ 802.11b: 1, 2, 5.5, 11Mbps</li> <li>■ 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54Mbps</li> <li>■ 802.11n: up to 150Mbps-single</li> </ul>				



	<ul style="list-style-type: none"> <li>■ 802.11n: up to 300Mbps-2x2 MIMO</li> <li>■ 802.11ac: up to 192.6Mbps (20MHz channel)</li> <li>■ 802.11ac: up to 400Mbps (40MHz channel)</li> <li>■ 802.11ac: up to 866.7Mbps (80MHz channel)</li> </ul>
Security	<ul style="list-style-type: none"> <li>■ WAPI</li> <li>■ WEP 64-bit and 128-bit encryption with H/W TKIP processing</li> <li>■ WPA/WPA2/WPA3 (Wi-Fi Protected Access)</li> <li>■ AES-CCMP hardware implementation as part of 802.11i security standard</li> </ul>

\* If you have any certification questions about output power please contact FAE directly.

### 1.3.3 Bluetooth

Features	Description				
<b>Bluetooth Standard</b>	Bluetooth 2.1 and 3.0+Enhanced Data Rate (EDR) + BT 5.3				
<b>Bluetooth VID/PID</b>	1286/204E				
<b>Frequency Range</b>	2402MHz~2480MHz				
<b>Modulation</b>	Header GFSK Payload 2M: $\pi/4$ -DQPSK Payload 3M: 8DPSK				
<b>Output Power</b>		Min	Typ	Max	Unit
	BDR	0	2	4	dBm
	EDR	0	2	4	dBm
	BLE	0	2	4	dBm
<b>Receiver Sensitivity</b>		Min	Typ	Max	Unit
	BDR		-83		dBm

### 1.3.4 Operating Conditions

Features	Description
<b>Operating Conditions</b>	
<b>Voltage</b>	3.3V±5%
<b>Operating Temperature</b>	-30 °C~ 85°C
<b>Operating Humidity</b>	less than 85% R.H.
<b>Storage Temperature</b>	-40 °C~ 125°C
<b>Storage Humidity</b>	less than 60% R.H.
<b>ESD Protection</b>	
<b>Human Body Model</b>	+2kV
<b>Charged Device Model</b>	+500V

## 2. Pin Definition

### 2.1. Pin map

	96	95	94	93	92	91	90	89	88	87	86	85	84	83	82	81	80	79	78	77				
	GND(G1)	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND	GND(G4)		
1	NC																					GND	76	
2	NC																						GND	75
3	NC																						GND	74
4	3.3V				GND(G5)		GND(G13)					GND(G21)				GND(G29)						VIO	73	
5	3.3V																					3.3V	72	
6	GND																						GND	71
7	NC				GND(G6)		GND(G14)					GND(G22)				GND(G30)							USB_DP	70
8	CONFIG_HOST[0]																						USB_DM	69
9	CONFIG_HOST[1]																						GND	68
10	CONFIG_HOST[2]																						NC	67
11	GPIO[17]UART_LTE_SOUT/TDO				GND(G7)		GND(G15)					GND(G23)				GND(G31)							GPIO[15]TMS/Host Wake WLAN	66
12	GPIO[16]UART_LTE_SIN/TDI																						GPIO[3]BT_LED	65
13	CONFIG_HOST[3]																						GPIO[2]WLAN_LED	64
14	NC				GND(G8)		GND(G16)					GND(G24)				GND(G32)							GPIO[22]PCI_E_W_DISABLE	63
15	GPIO[1]																						GND	62
16	NC																						GPIO[6]PCM_CLK	61
17	GND				GND(G9)							GND(G25)				GND(G33)							GPIO[5]PCM_OUT	60
18	GPIO[25]																						GPIO[4]PCM_IN	59
19	NC																						GPIO[7]PCM_SYNC	58
20	GND																						GPIO[11]UART_RTSn	57
21	GPIO[26]				GND(G10)							GND(G26)				GND(G34)							GPIO[9]UART_SIN	56
22	GPIO[27]																						GPIO[8]UART_SOUT	55
23	GND																						GPIO[10]UART_CTSn	54
24	ATEST0				GND(G11)		GND(G19)					GND(G27)				GND(G35)							GPIO[12]UARTHostWakeBT	53
25	NC																						SD_CLK	52
26	GND																						SD_CMD	51
27	SLP_CLK				GND(G12)		GND(G20)					GND(G28)				GND(G36)							SD_DAT[0]	50
28	GPIO[13]BT_IRQ(0)																						SD_DAT[1]	49
	GND(G2)	PCI_E_WAKEn	PCI_E_CLKREQn	GPIO[21]/PCI_E_PERStn	GND	PCI_E_RCLK_N	PCI_E_RCLK_P	GND	PCI_E_TX_N/USB3.0_TX_N	PCI_E_TX_P/USB3.0_TX_P	GND	PCI_E_RX_N/USB3.0_RX_N	PCI_E_RX_P/USB3.0_RX_P	GND	GPIO[0]/CLK_REQ	NC	VIO_SD	PDn	GPIO[14]/TCK/WLAN Wake Host	SD_DAT[3]	SD_DAT[2]	GND(G3)		
		29	30	31	32	33	34	35	36	37	38	39	40	41	42	43	44	45	46	47	48			

## 2.2 Pin Table

Pin No	Definition	Basic Description	Voltage	Type
1	NC	NC		
2	NC	NC		
3	NC	NC		
4	3.3V	3.3V Power Supply	3.3V	I
5	3.3V	3.3V Power Supply	3.3V	I
6	GND	System Ground Pin		GND
7	NC	NC		
8	CONFIG_HOST[0]	Configuration: CONFIG_HOST[0]		
9	CONFIG_HOST[1]	Configuration: CONFIG_HOST[1]		
10	CONFIG_HOST[2]	Configuration: CONFIG_HOST[2]		
11	GPIO[17] /UART_LTE_SOUT/TDO	GPIO[17] / UART_LTE_SOUT/TDO (output)	VIO	O
12	GPIO[16]/ UART_LTE_SIN/TDI	GPIO[16] / UART_LTE_SIN/TDI (input)	VIO	I
13	CONFIG_HOST[3]	Configuration: CONFIG_HOST[3]		
14	NC	NC		
15	GPIO[1]	GPIO[1] (input/output)	VIO	I/O
16	NC	NC		I/O
17	GND	System Ground Pin		GND
18	GPIO[25]	GPIO[25] (input/output)	VIO	I/O
19	NC	NC		
20	GND	System Ground Pin		GND
21	GPIO[26]	GPIO[26] (input/output)	VIO	I/O
22	GPIO[27]	GPIO[27] (input/output)	VIO	I/O
23	GND	System Ground Pin		
24	ATEST0	NC, reserved for debug		I
25	NC	NC		I/O
26	GND	System Ground Pin		GND
27	SLP_CLK	Sleep Clock Input Used for WLAN and Bluetooth low-power modes. External sleep clock of 32.768 KHz must be used for auto reference clock calibration and for WLAN/Bluetooth low power operation.	VIO	I
28	GPIO[13]/BT IRQ(O)	GPIO[13]/ BT Wake Host(active low) (output)	VIO	O
29	PCIE_WAKEn	PCIe wake signal (input/output) (active low)	VIO	I/O
30	PCIE_CLKREQn	PCIe clock request (input/output) (active low)	VIO	I/O
31	GPIO[21]/PCIE_PERSTn	PCIe host indication to reset the device (input) (active low)	VIO	I
32	GND	System Ground Pin		GND
33	PCIE_RCLK_N	PCI Express Differential Clock Input—Negative	1.8V(internal)	I
34	PCIE_RCLK_P	PCI Express Differential Clock Input—Positive	1.8V(internal)	I
35	GND	System Ground Pin		GND
36	PCIE_TX_N	PCI Express Transmit Data—Negative	1.8V(internal)	O
37	PCIE_TX_P	PCI Express Transmit Data—Positive	1.8V(internal)	O
38	GND	System Ground Pin		GND
39	PCIE_RX_N/USB3.0_RX_N	PCI Express Receive Data—Negative / USB 3.0 RX negative	1.8V(internal)	I
40	PCIE_RX_P/USB3.0_RX_P	PCI Express Receive Data—Positive / USB 3.0 RX positive	1.8V(internal)	I

41	GND	System Ground Pin		GND
42	GPIO[0]/CLK_REQ	GPIO[0] (input/output)	VIO	O
43	NC	NC		
44	VIO_SD	1.8V/3.3V Digital I/O SDIO Power Supply	VIO_SD	I
45	PDn	Full Power Down (input) (active low)	3.3V	I
46	GPIO[14] /TCK/WLAN Wake Host	GPIO[14]/TCK/WLAN Wake Host(active low) (output)	VIO	O
47	SD_DAT[3]	SDIO Data line Bit[3]	VIO_SD	I/O
48	SD_DAT[2]	SDIO Data line Bit[2]	VIO_SD	I/O
49	SD_DAT[1]	SDIO Data line Bit[1]	VIO_SD	I/O
50	SD_DAT[0]	SDIO Data line Bit[0]	VIO_SD	I/O
51	SD_CMD	SDIO Command/response (input/output)	VIO_SD	I/O
52	SD_CLK	SDIO Clock input	VIO_SD	I
53	GPIO[12] / UART Host Wake BT	GPIO[12]/ UART Host Wake BT(active low) (input)	VIO	I
54	GPIO[10] / UART_CTSn	GPIO[10] / UART_CTSn (input)	VIO	I
55	GPIO[8] / UART_SOUT	GPIO[8] / UART_SOUT (output)	VIO	O
56	GPIO[9] / UART_SIN	GPIO[9] / UART_SIN (input)	VIO	I
57	GPIO[11] / UART_RTSn	GPIO[11] / UART_RTSn (output)	VIO	O
58	GPIO[7] / PCM_SYNC	GPIO[7] / PCM_SYNC (input/output)	VIO	I/O
59	GPIO[4] / PCM_IN	GPIO[4] / PCM_IN (input)	VIO	I
60	GPIO[5] / PCM_OUT	GPIO[5] / PCM_OUT (output)	VIO	O
61	GPIO[6] / PCM_CLK	GPIO[6] / PCM_CLK (input)	VIO	I
62	GND	System Ground Pin		GND
63	GPIO[22] / PCIE_W_DISABLEn	GPIO[22] / PCIE_W_DISABLEn (input)	VIO	I
64	GPIO[2] / WLAN_LED	LED_OUT_WLAN (output)	VIO	O
65	GPIO[3] / BT_LED	LED_OUT_BT (output)	VIO	O
66	GPIO[15] / TMS/ Host Wake WLAN	GPIO[15] / JTAG TMS/ Host Wake WLAN (input)	VIO	I
67	NC	NC		
68	GND	System Ground Pin		GND
69	Reserved	Reserved	3.3V	I/O
70	Reserved	Reserved	3.3V	I/O
71	GND	System Ground Pin		GND
72	3.3V	3.3V Power Supply	3.3V	I
73	VIO	Digital I/O Power Supply	VIO	I
74	GND	System Ground Pin		
75	GND	System Ground Pin		
76	GND	System Ground Pin		
77	GND	System Ground Pin		
78	GND	System Ground Pin		
79	GND	System Ground Pin		
80	GND	System Ground Pin		

81	GND	System Ground Pin		
82	GND	System Ground Pin		
83	GND	System Ground Pin		
84	GND	System Ground Pin		
85	GND	System Ground Pin		
86	GND	System Ground Pin		
87	GND	System Ground Pin		
88	GND	System Ground Pin		
89	GND	System Ground Pin		
90	GND	System Ground Pin		
91	GND	System Ground Pin		
92	GND	System Ground Pin		
93	GND	System Ground Pin		
94	GND	System Ground Pin		
95	GND	System Ground Pin		
96	GND	System Ground Pin		
G1~G36	GND	System Ground Pin		

**Notes:**

1. PCIE Impedance targets: Single-ended Z of 60 ohms +- 15% . Differential Impedance of ~100 ohm +- 20%.
2. USB Impedance targets: D+/D- are differential and should have 90ohms impedance.
3. \* Implement by different hardware version.

**Note: Interface supports and combinations as shown below:**

Scenario	WLAN	BT	Strap value, CON[2:0]
1	SDIO	UART	000
2	reserved	reserved	001
3	reserved	reserved	010
4	PCIe	UART	011
5	reserved	reserved	100
6	reserved	reserved	101
7	reserved	reserved	110
8	reserved	reserved	111

**\*Configuration pins:**

Pin No.	Configuration
10	CON[2]
9	CON[1]
8	CON[0]

### 3. Electrical Characteristics

#### 3.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Minimum	Typical	Maximum	Unit
Pin73/ VIO	Host I/O power supply	--	--	1.8	2.2	V
		--	--	2.5	3.0	
		--	--	3.3	4.0	
Pin44/ VIO_SD	SDIO power supply	--	--	1.8	2.2	
		--	--	3.3	4.0	
Pin4,5,72/ 3.3V	3.3V VBAT input	-	-	3.3	3.63	V
Tstorage	Storage Temperature	-	-40	-	125	°C

#### 3.2 Recommended Operating Conditions

Symbol	Parameter	Condition	Minimum	Typical	Maximum	Units
Pin73/ VIO	1.8V/2.5V/3.3V digital I/O power supply	--	1.62	1.8	1.98	V
		--	2.25	2.5	2.75	
		--	2.97	3.3	3.63	
Pin44/ VIO_SD	1.8V/3.3V digital I/O SDIO power supply	--	1.62	1.8	1.98	V
		--	2.97	3.3	3.63	
Pin4,5,72/ 3.3V	3.3V VBAT input	--	3.14	3.14	3.3	V
T <sub>A</sub>	Ambient operating temperature	--	-30		85	°C

### 3.3 Digital IO Pin DC Characteristics

#### 3.3.1 DC Electricals-1.8V Operation (VIO)

Symbol	Parameter	Minimum	Typical	Maximum	Unit
V <sub>IH</sub>	Input high voltage	0.7*V <sub>IO</sub>	-	V <sub>IO</sub> +0.4	V
V <sub>IL</sub>	Input low voltage	-0.4	-	0.3*V <sub>IO</sub>	
V <sub>OH</sub>	Output high voltage	V <sub>IO</sub> -0.4	-	-	
V <sub>OL</sub>	Output low voltage	-	-	0.4	
V <sub>HYS</sub>	Input Hysteresis	100			mV

#### 3.3.2 3.3V Operation (VIO)

Symbol	Parameter	Minimum	Typical	Maximum	Unit
V <sub>IH</sub>	Input high voltage	0.7*V <sub>IO</sub>	-	V <sub>IO</sub> +0.4	V
V <sub>IL</sub>	Input low voltage	-0.4	-	0.3*V <sub>IO</sub>	
V <sub>OH</sub>	Output High Voltage	V <sub>IO</sub> -0.4	-	-	
V <sub>OL</sub>	Output Low Voltage	-	-	0.4	
V <sub>HYS</sub>	Input Hysteresis	100			mV

#### 3.3.3 1.8V Operation (VIO\_SD)

Symbol	Parameter	Minimum	Typical	Maximum	Unit
V <sub>IH</sub>	Input high voltage	0.7*V <sub>IO_SD</sub>	-	V <sub>IO_SD</sub> +0.4	V
V <sub>IL</sub>	Input low voltage	-0.4	-	0.3*V <sub>IO_SD</sub>	
V <sub>OH</sub>	Output High Voltage	V <sub>IO_SD</sub> -0.4	-	-	
V <sub>OL</sub>	Output Low Voltage	-	-	0.4	
V <sub>HYS</sub>	Input Hysteresis	100			mV

#### 3.3.4 3.3V Operation (VIO\_SD)

Symbol	Parameter	Minimum	Typical	Maximum	Unit
V <sub>IH</sub>	Input high voltage	0.7*V <sub>IO_SD</sub>	-	V <sub>IO_SD</sub> +0.4	V
V <sub>IL</sub>	Input low voltage	-0.4	-	0.3* V <sub>IO_SD</sub>	
V <sub>OH</sub>	Output High Voltage	V <sub>IO_SD</sub> -0.4	-	-	
V <sub>OL</sub>	Output Low Voltage	-	-	0.4	
V <sub>HYS</sub>	Input Hysteresis	100			mV



### 3.4 Host Interface

#### 3.4.1. SDIO Interface

The AW-CM276NF supports a SDIO device interface that conforms to the industry standard SDIO Full-Speed card specification and allows a host controller using the SDIO bus protocol to access the Wireless module device.

The AW-CM276NF acts as the device on the SDIO bus. The host unit can access registers of the SDIO interface directly and can access shared memory in the device through the use of BARs and a DMA engine.

The SDIO device interface main features include:

Supports SDIO 3.0 Standard

On-chip memory used for CIS

Supports SPI, 1-bit SDIO, and 4-bit SDIO transfer modes

Special interrupt register for information exchange

Allows card to interrupt host

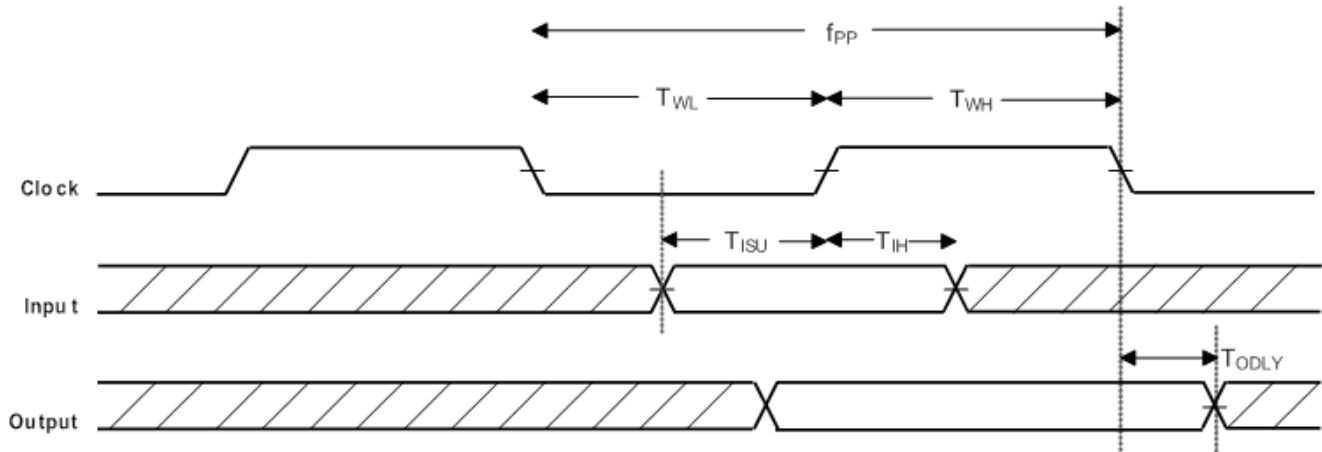
##### 3.4.1.1. SDIO Interface Signal Description

Pin Name	Signal Name	Type	Description
SD_CLK	CLK	I/O	SDIO 1-bit mode: Clock SDIO SPI mode: Clock
SD_CMD	CMD	I/O	SDIO 1-bit mode: Command line SDIO SPI mode: Data input
SD_DAT[3]	DAT3	I/O	SDIO 4-bit mode: Data line bit [3] SDIO 1-bit mode: Not used SDIO SPI mode: Chip select (active low)
SD_DAT[2]	DAT2	I/O	SDIO 4-bit mode: Data line bit [2] or Read Wait (optional) SDIO 1-bit mode: Read Wait (optional) SDIO SPI mode: Reserved
SD_DAT[1]	DAT1	I/O	SDIO 4-bit mode: Data line bit [1] SDIO 1-bit mode: Interrupt SDIO SPI mode: Interrupt

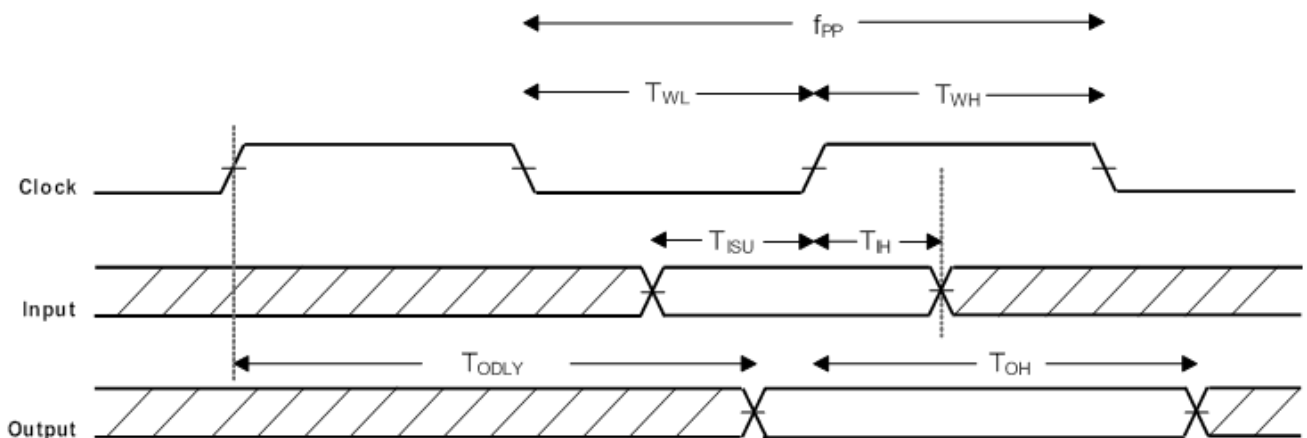
SD_DAT[0]	DAT0	I/O	SDIO 4-bit mode: Data line bit [0] SDIO 1-bit mode: Data line SDIO SPI mode: Data output
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### 3.4.1.2. Default Speed, High Speed Modes (3.3V)

#### SDIO Protocol Timing Diagram – Default Speed Mode (3.3V)



#### SDIO Protocol Timing Diagram – HighSpeed Mode (3.3V)



#### Table shows SDIO Timing Data—Default Speed, High Speed Modes (3.3V)

NOTE: Over full range of values specified in the Recommended Operating Conditions unless otherwise specified.

Symbol	Parameter	Condition	Min	Typ	Max	Units
f <sub>PP</sub>	Clock Frequency	Default Speed	0	--	25	MHz
		High Speed	0	--	50	MHz
T <sub>WL</sub>	Clock Low Time	Default Speed	10	--	--	ns
		High Speed	7	--	--	ns
T <sub>WH</sub>	Clock High Time	Default Speed	10	--	--	ns
		High Speed	7	--	--	ns
T <sub>ISU</sub>	Input Setup Time	Default Speed	5	--	--	ns
		High Speed	6	--	--	ns
T <sub>IH</sub>	Input Hold Time	Default Speed	5	--	--	ns
		High Speed	2	--	--	ns
T <sub>ODLY</sub>	Output Delay Time CL ≤ 40 pF (1 card)	Default Speed	--	--	14	ns
		High Speed	---	-1	4	ns
T <sub>OH</sub>	Output Hold Time	High Speed	2.5	--	--	ns

### 3.4.1.3 SDR12, SDR25, SDR50 Modes (up to 100MHz) (1.8V)

#### SDIO Protocol Timing Diagram – SDR12,SDR25,SDR50 Modes (up to 100MHz) (1.8V)

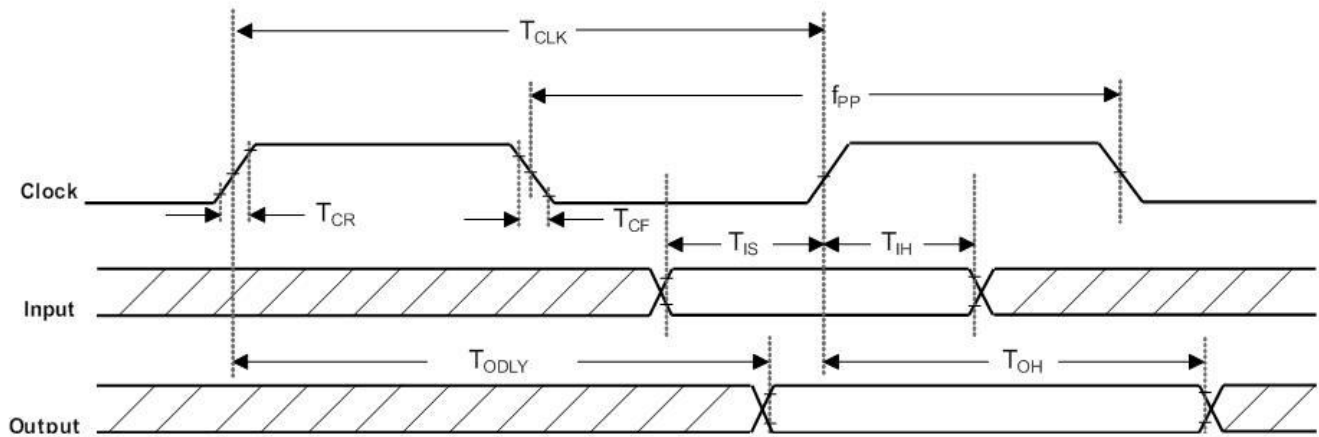


Table shows SDIO Timing Data—SDR12,SDR25,SDR50 Modes (up to 100MHz) (1.8V)

Symbol	Parameter	Condition	Min	Typ	Max	Units
$f_{PP}$	Clock frequency	SDR12/25/50	25	--	100	MHz
$T_{IS}$	Input setup time	SDR12/25/50	3	--	--	ns
$T_{IH}$	Input hold time	SDR12/25/50	0.8	--	--	ns
$T_{CLK}$	Clock time	SDR12/25/50	10	--	40	ns
$T_{CR}, T_{CF}$	Rise time, fall time $T_{CR}, T_{CF} < 2$ ns (max) at 100 MHz $C_{CARD} = 10$ pF	SDR12/25/50	--	--	$0.2 * T_{CLK}$	ns
$T_{ODLY}$	Output delay time $C_L \leq 30$ pF	SDR12/25/50	--	--	7.5	ns
$T_{OH}$	Output hold time $C_L = 15$ pF	SDR12/25/50	1.5	--	--	ns

### 3.4.1.4 SDR104 Modes (208MHz) (1.8V)

#### SDIO Protocol Timing Diagram –SDR104 Mode (208MHz)

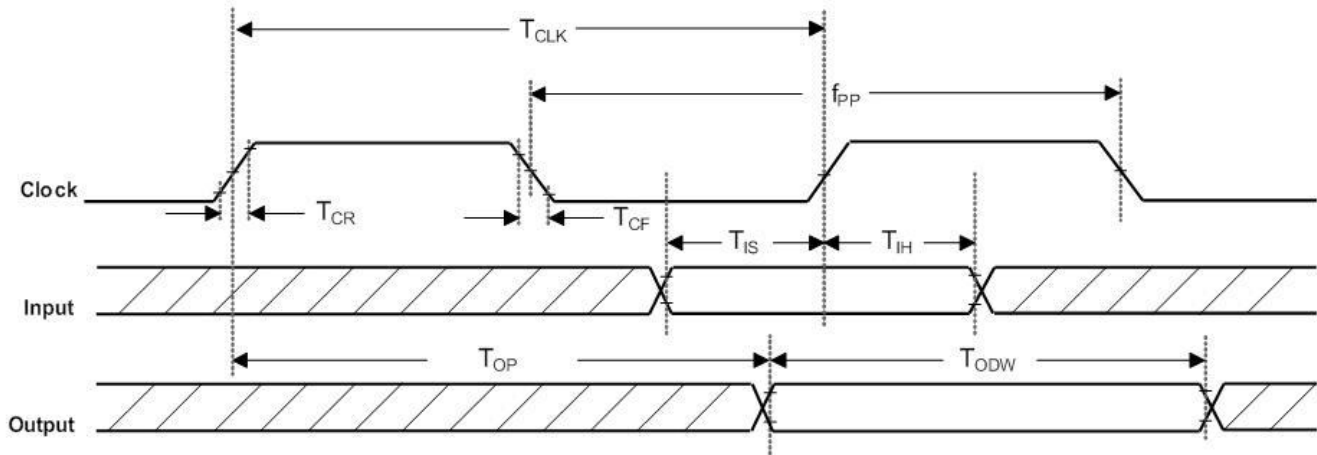


Table shows SDIO Timing Data—SDR104 Mode (208MHz)

Symbol	Parameter	Condition	Min	Typ	Max	Units
$f_{PP}$	Clock frequency	SDR104	0	--	208	MHz
$T_{IS}$	Input setup time	SDR104	1.4	--	--	ns
$T_{IH}$	Input hold time	SDR104	0.8	--	--	ns
$T_{CLK}$	Clock time	SDR104	4.8	--	--	ns
$T_{CR}, T_{CF}$	Rise time, fall time $T_{CR}, T_{CF} < 0.96$ ns (max) at 208 MHz $C_{CARD} = 10$ pF	SDR104	--	--	$0.2 * T_{CLK}$	ns
$T_{OP}$	Card output phase	SDR104	0	--	10	ns
$T_{ODW}$	Output timing of variable data window	SDR104	2.88	--	--	ns

### 3.4.2 PCI Express Interface

#### 3.4.2.1 Differential Tx Output Electricals

Symbol	Parameter	Min	Typ	Max	Units
UI	Unit interval Each UI is 400 ps ±300 PPM. UI does not account for SSC dictated variations.	399.98	400	400.12	ps
V <sub>Tx_DIFFpp</sub>	Differential peak-to-peak output voltage $V_{Tx\_DIFFpp} = 2 *  V_{Tx\_D+} - V_{Tx\_D-} $	0.800	--	1.2	V
V <sub>Tx_DE_RATIO</sub>	De-emphasized differential output voltage (ratio)	-3.0	-3.5	-4.0	db
T <sub>Rx_EYE</sub>	Minimum Tx eye width	0.75	--	--	UI
T <sub>Rx_EYE_MEDIAN_MAX_JIT</sub>	Maximum time between jitter median and maximum deviation from median	--	--	0.125	UI
T <sub>Tx_RISE</sub> , T <sub>Tx_FALL</sub>	D+/D- Tx output rise/fall time	0.125	--	--	UI
V <sub>Tx_CM_DC_ACTIVE_IDLE_DELTA</sub>	Absolute delta of DC common mode voltage during L0 and electrical idle	0-	-	100	mV
V <sub>Tx_CM_DC_LINE_DELTA</sub>	Absolute delta of DC common mode voltage between D+ and D-	0-	-	25	mV
V <sub>Tx_IDLE_DIFFp</sub>	Electrical idle differential peak output voltage	0	--	20	mV
V <sub>Tx_RCV_DETECT</sub>	Voltage change allowed during receiver detection	--	--	600	mV
V <sub>Tx_DC_CM</sub>	Tx DC common mode voltage	--	--	3.6	V
I <sub>Tx_SHORT</sub>	Tx short circuit current limit	--	--	90	mA
T <sub>Tx_IDLE_MIN</sub>	Minimum time spent in electrical idle	50	--	--	UI
T <sub>Tx_IDLE_SET_TO_IDLE</sub>	Maximum time to transition to a valid electrical idle after sending an electrical idle ordered set	--	--	20	UI
T <sub>Tx_IDLE_TO_DIFF_DATA</sub>	Maximum time to transition to valid Tx specifications after leaving an electrical idle condition	--	--	20	UI
RL <sub>Tx_DIFF</sub>	Differential return loss	10	--	--	dB
RL <sub>Tx_CM</sub>	Common mode return loss	6	--	--	dB
C <sub>Tx</sub>	AC coupling capacitor	75	--	200	nF
T <sub>Crosstalk</sub>	Crosstalk random timeout	0	--	1	ms

### 3.4.2.2 Differential Rx Output Electricals

Symbol	Parameter	Min	Typ	Max	Units
UI	Unit interval Each UI is 400 ps $\pm$ 300 ppm. UI does not account for SSC dictated variations.	399.98	400	400.12	ps
V <sub>Rx_DIFFpp</sub>	Differential peak-to-peak voltage $V_{Rx\_DIFFpp} = 2 *  V_{Rx-D+} - V_{Rx-D-} $	0.175	--	1.2	V
T <sub>Rx_EYE</sub>	Minimum receiver eye width	0.4	--	--	UI
T <sub>Rx_EYE_MEDIAN_MAX_JIT</sub>	Maximum time between jitter median and maximum deviation from median	--	--	0.3	UI
V <sub>Rx_CM_ACp</sub>	AC peak common mode input voltage	--	--	150	mV
RL <sub>Rx_DIFF</sub>	Differential return loss	10	--	--	dB
RL <sub>Rx_CM</sub>	Common mode return loss	6	--	--	dB
Z <sub>Rx_DIFF_DC</sub>	DC differential input impedance	80	100	120	$\Omega$
Z <sub>Rx_DC</sub>	DC input impedance	40	50	60	$\Omega$
Z <sub>Rx_HIGH_IMP_DC_POS</sub>	Powered down DC input impedance positive	50	--	--	k
Z <sub>Rx_HIGH_IMP_DC_NEG</sub>	Powered down DC input impedance negative	1	--	--	k $\Omega$
V <sub>Rx_IDLE_DET_DIFFpp</sub>	Electrical idle detect threshold	65	--	175	mV
T <sub>Rx_IDLE_DET_DIFF_ENTERTIME</sub>	Unexpected electrical idle enter detect threshold integration time	--	--	10	ms
L <sub>Rx_SKEW</sub>	Total skew	---	-2	0	ns

### 3.4.3. High-Speed UART Interface

The AW-CM276NF supports a high-speed Universal Asynchronous Receiver/Transmitter (UART) interface, compliant to the industry standard 16550 specification. High-speed baud rates are supported to provide the physical transport between the device and the host for exchanging Bluetooth data. Table shows the rates supported.

The UART interface features include:

- FIFO mode permanently selected for transmit and receive operations
- Two pins for transmit and receive operations
- Two flow control pins

Interrupt triggers for low-power, high throughput operation

The UART interface operation includes:

- Upload boot code to the internal CPU (for debug purposes)

- Support diagnostic tests

- Support data input/output operations for peripheral devices connected through a standard UART interface

#### UART Baud Rates Supported

Baud Rate				
1200	38400	460800	1500000	3000000
2400	57600	500000	1843200	3250000
4800	76800	921600	2000000	3692300
9600	115200	1000000	2100000	4000000
19200	230400	1382400	2764800	--

### 3.4.3.1. UART Interface Signal Description

Table shows the standard UART signal names on the device.

Signal Name	16550 Standard Pin Name	Description
<i>Data Bus</i>		
UART_SIN	SIN	Serial data input from modem, data set, or peripheral device
UART_SOUT	SOUT	Serial data output from modem, data set, or peripheral device
<i>Modem Control</i>		
UART_RTSN	RTS	Request To Send output to modem, data set, or peripheral device (active low)
UART_CTSN	CTS	Clear To Send input from modem, data set, or peripheral device (active low)

### 3.4.3.2. UART Interface Functional Description

#### 3.4.3.2.1. Booting from UART

When booting from the UART, the AW-CM276NF device has the following requirements:



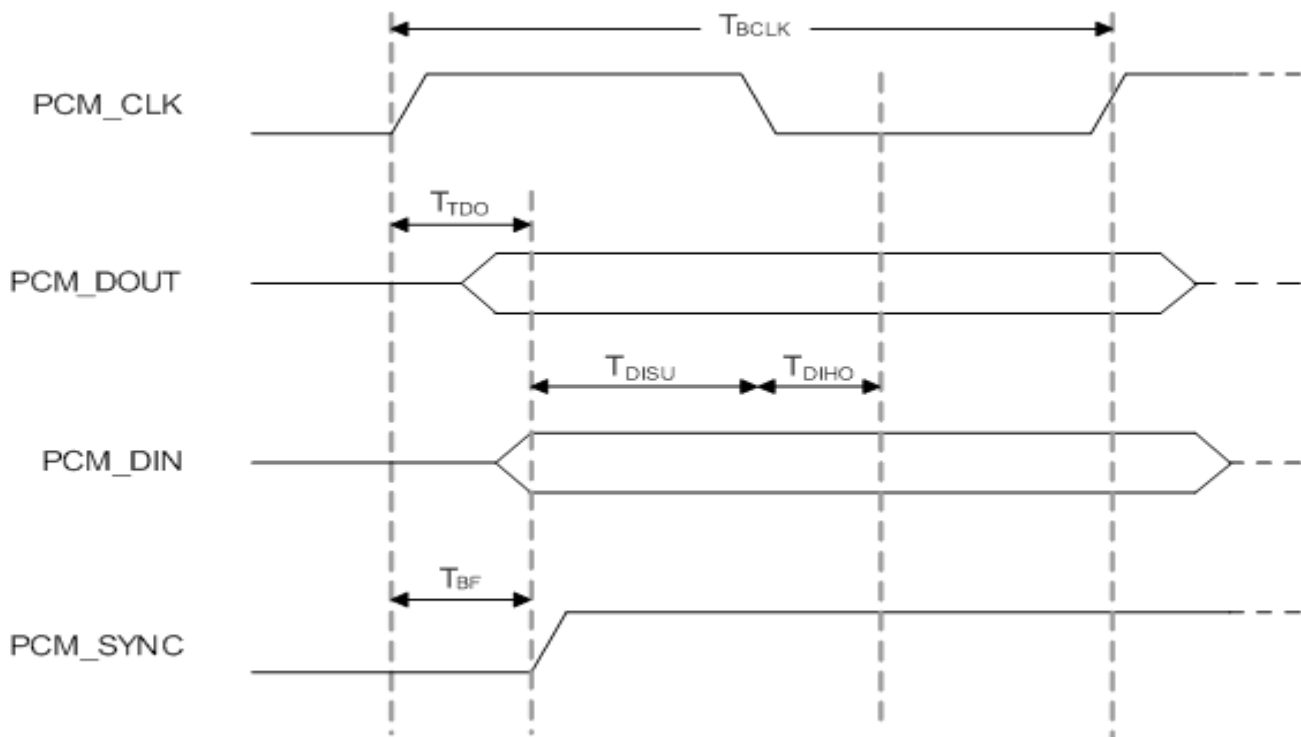
System Requirement	Description
Number of data bits	8 bits
Stop bits	1 bit
Parity	No parity
Baud Rate	115200

### 3.4.3.2.2. UART as Test Port

Test diagnostic programs may be uploaded to the CPU through the UART interface. During execution, the diagnostic program transmits performance and status information through the UART by performing a write to the PBU address space designated to the UART.

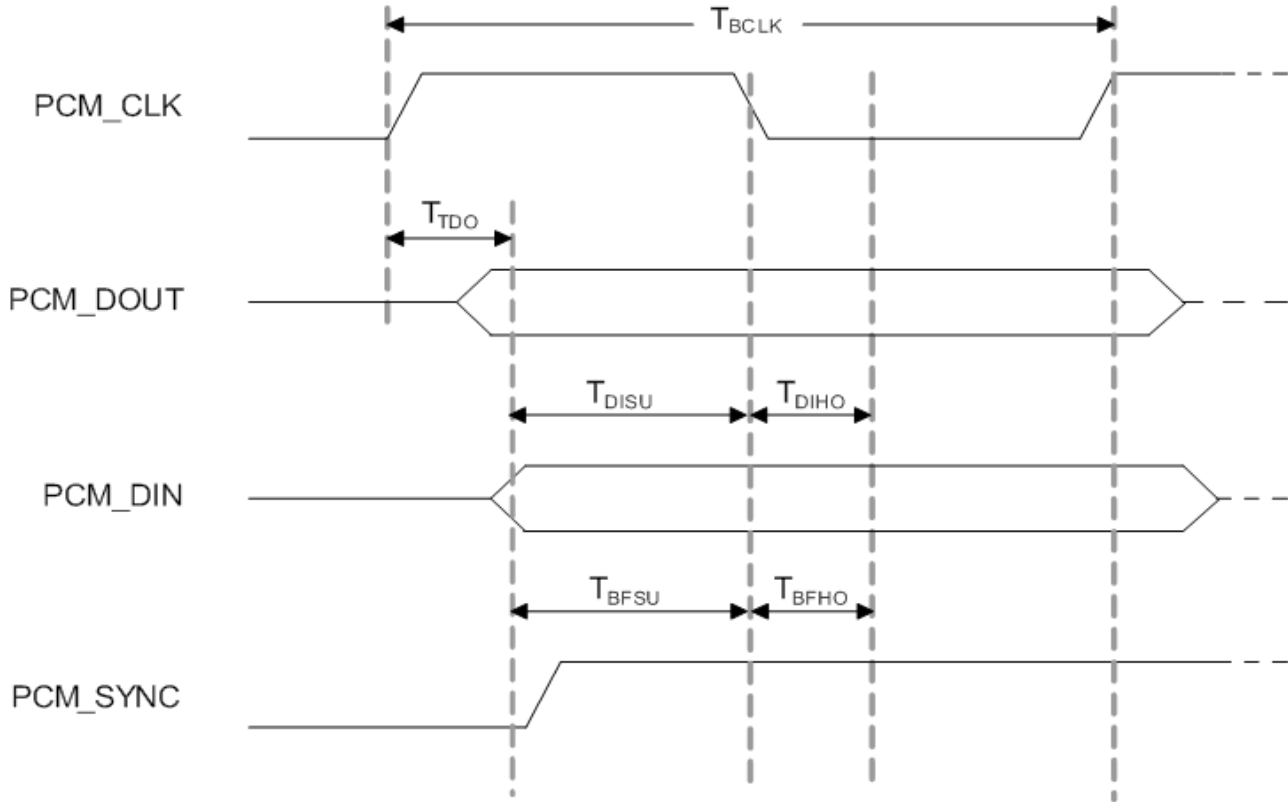
## 3.4.4. PCM Interface

### 3.4.4.1. PCM Timing Specification – Master Mode



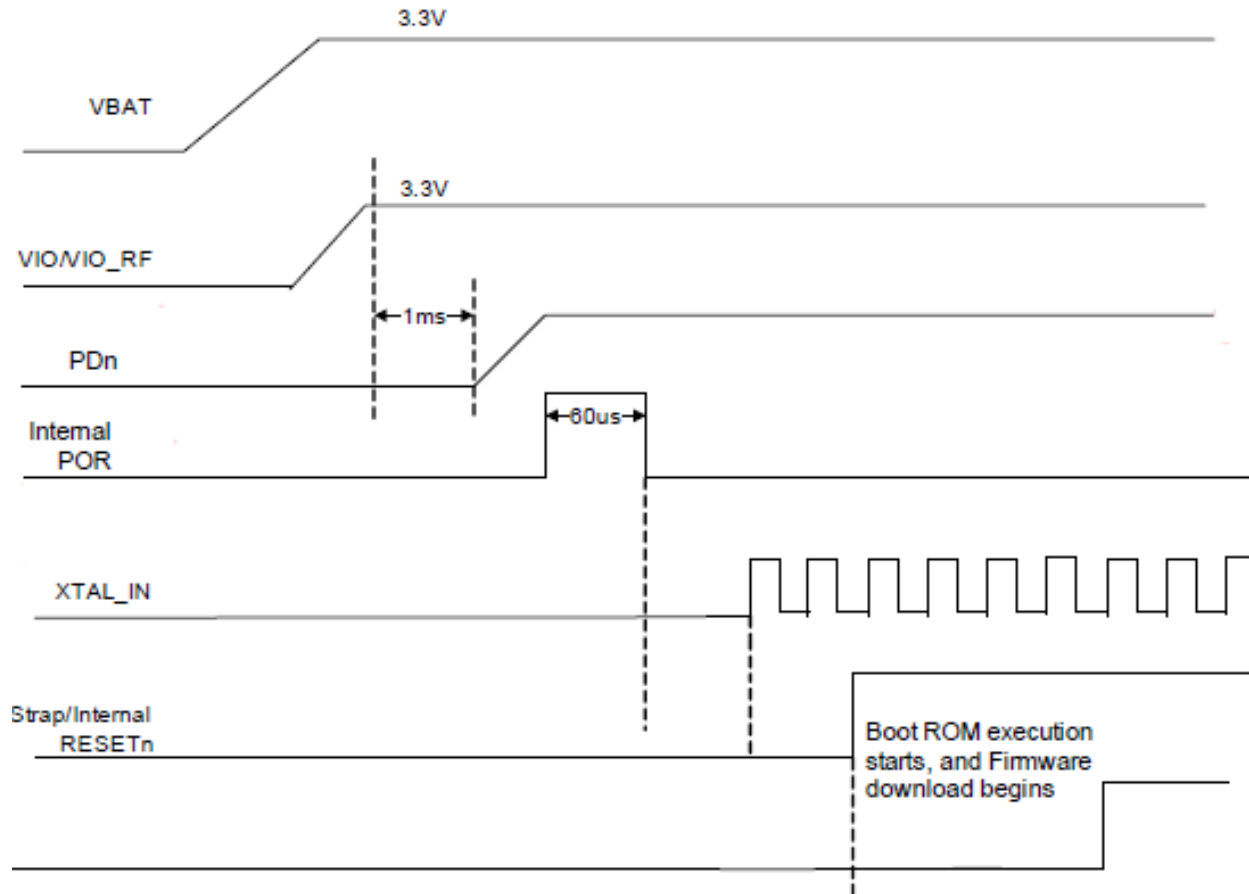
Symbol	Parameter	Condition	Min	Typ	Max	Units
$F_{BCLK}$	--	--	--	2/2.048	--	MHz
Duty Cycle <sub>BCLK</sub>	--	--	0.4	0.5	0.6	--
$T_{BCLK\ rise/fall}$	--	--	--	3	--	ns
$T_{DO}$	--	--	--	--	15	ns
$T_{DISU}$	--	--	20	--	--	ns
$T_{DHO}$	--	--	15	--	--	ns
$T_{BF}$	--	--	--	--	15	ns

### 3.4.4.2. PCM Timing Specification – Slave Mode



Symbol	Parameter	Condition	Min	Typ	Max	Unit
$F_{BCLK}$	--	--	--	2/2.048	--	MHz
Duty Cycle <sub>BCLK</sub>	--	--	0.4	0.5	0.6	--
$T_{BCLK \text{ rise/fall}}$	--	--	--	3	--	ns
$T_{DO}$	--	--	--	--	30	ns
$T_{DISU}$	--	--	15	--	--	ns
$T_{DIHO}$	--	--	10	--	--	ns
$T_{BFSU}$	--	--	15	--	--	ns
$T_{BFHO}$	--	--	10	--	--	ns

### 3.5. Power up Timing Sequence



#### 3.5.1. Reset Configuration

The AW-CM276NF is reset to its default operating state under the following conditions:

- Power-on reset (POR)
- Software/Firmware reset
- External pin for power down (PDn)

### 3.6 Power Consumption

#### 3.6.1 WLAN

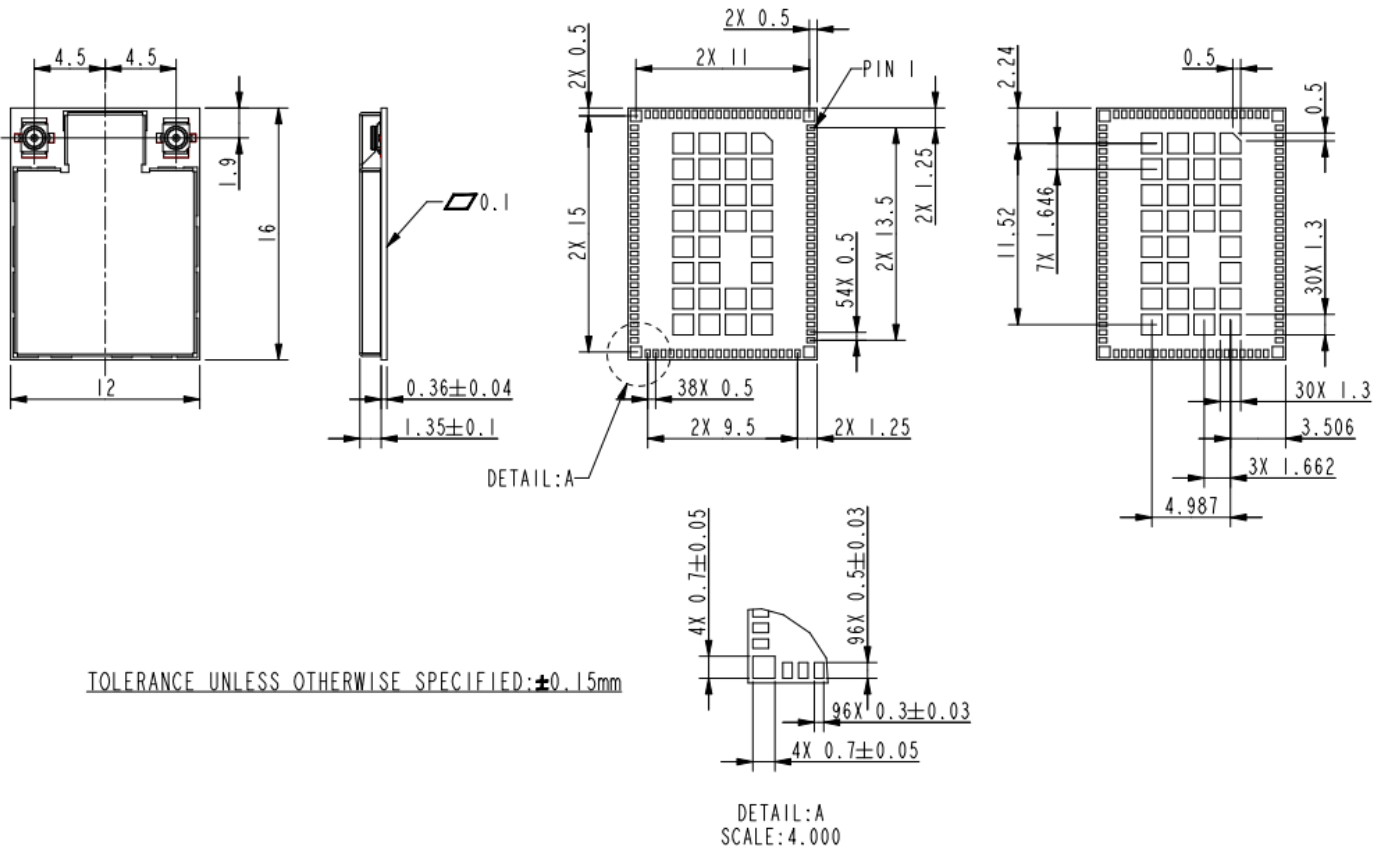
No.	Item			VBAT_IN=3.3V(mA)				
				Max.		Avg.		
1	Power down			0.2		0.2		
2.	Deep sleep			0.82		0.80		
3.	PS Mode 2.4G Band			98.2		5.3		
4	PS Mode 5G Band			150.2		6.8		
No.	Item			3.3V_VBAT=3.3V(mA)				
Band (GHz)	Mode	BW (MHz)	RF Power (dBm)	Transmit			Receive	
				Max.	Avg.	DUTY %	Max.	Avg.
2.4	11b@1M	20	17	324.7	322.0	99	71.2	59.9
	11g@6M	20	16	292.1	289.8	99	74.7	63.4
	11n@MCS8 MIMO	20	16	577.6	576.2	97	93.8	85.8
	11n@MCS15 MIMO	20	16	526.8	526.1	86	92.0	83.9
	11n@MCS8 MIMO	40	14	484.6	483.7	95	109.9	101.6
	11n@MCS15 MIMO	40	14	425.3	424.8	82	106.0	97.9
5	11a@6M	20	13	315.0	314.4	98	93.7	84.2
	11n@MCS8 MIMO	20	13	610.9	610.2	97	121.7	115.3
	11n@MCS15 MIMO	20	13	560.3	559.7	86	121.5	113.7
	11n@MCS8 MIMO	40	12	570.3	569.4	95	146.0	141.7
	11ac@MCS0 NSS2	20	13	610.5	609.2	97	122.3	116.2
	11ac@MCS0 NSS2	40	12	570.1	569.1	95	147.1	143.5
	11ac@MCS0 NSS2	80	10	521.8	521.1	92	167.1	154.5
	11ac@MCS9 NSS2	80	10	466.1	465.3	78	167.2	155.8

#### 3.6.2 Bluetooth

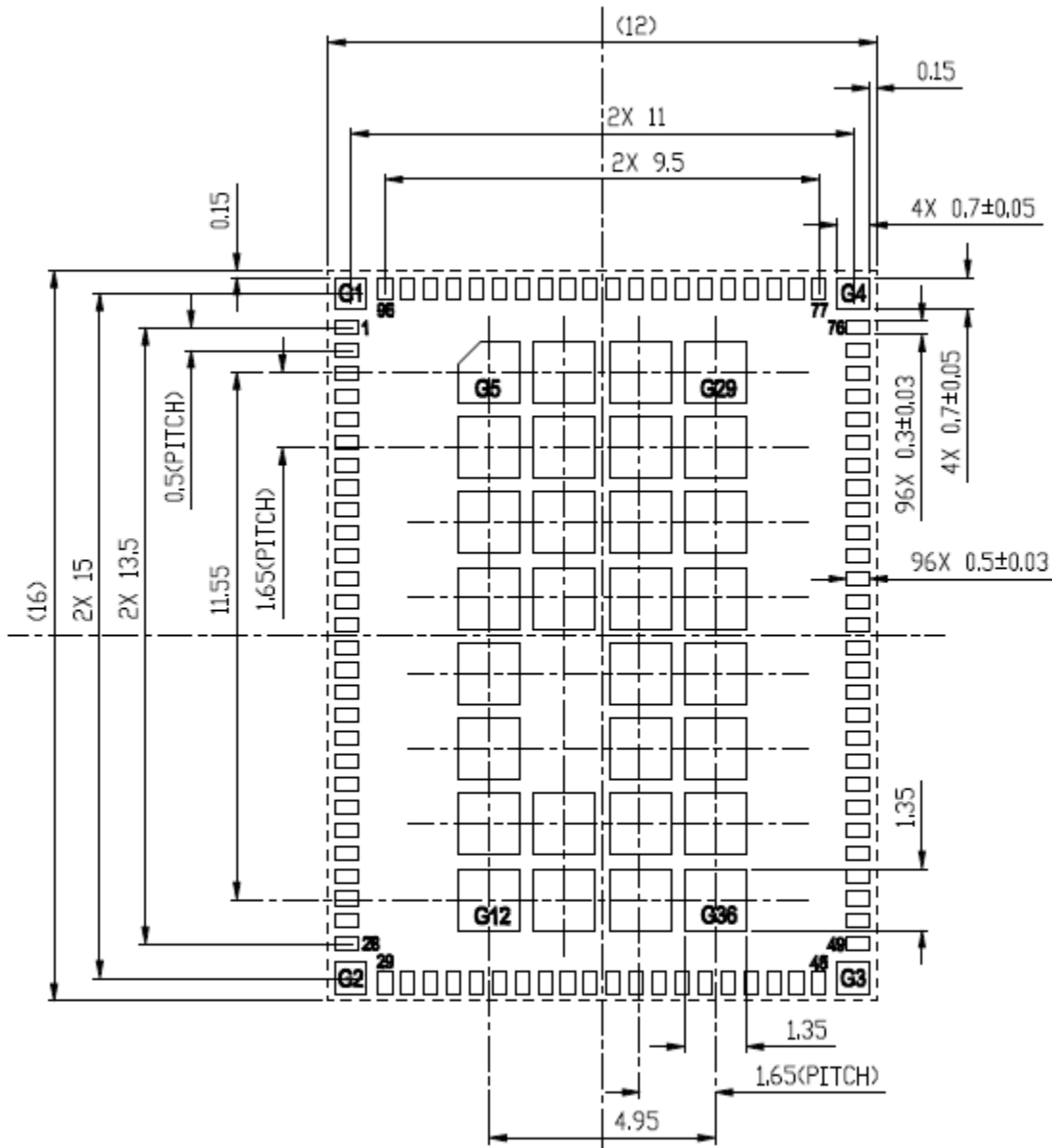
No.	Mode	3.3V_VBAT=3.3V(mA)	
		Max.	Avg.
1	Connect BT device	15.9	1.2
2	A2DP (send audio)	28.7	13.8

## 4. Mechanical Information

### 4.1 Mechanical Drawing

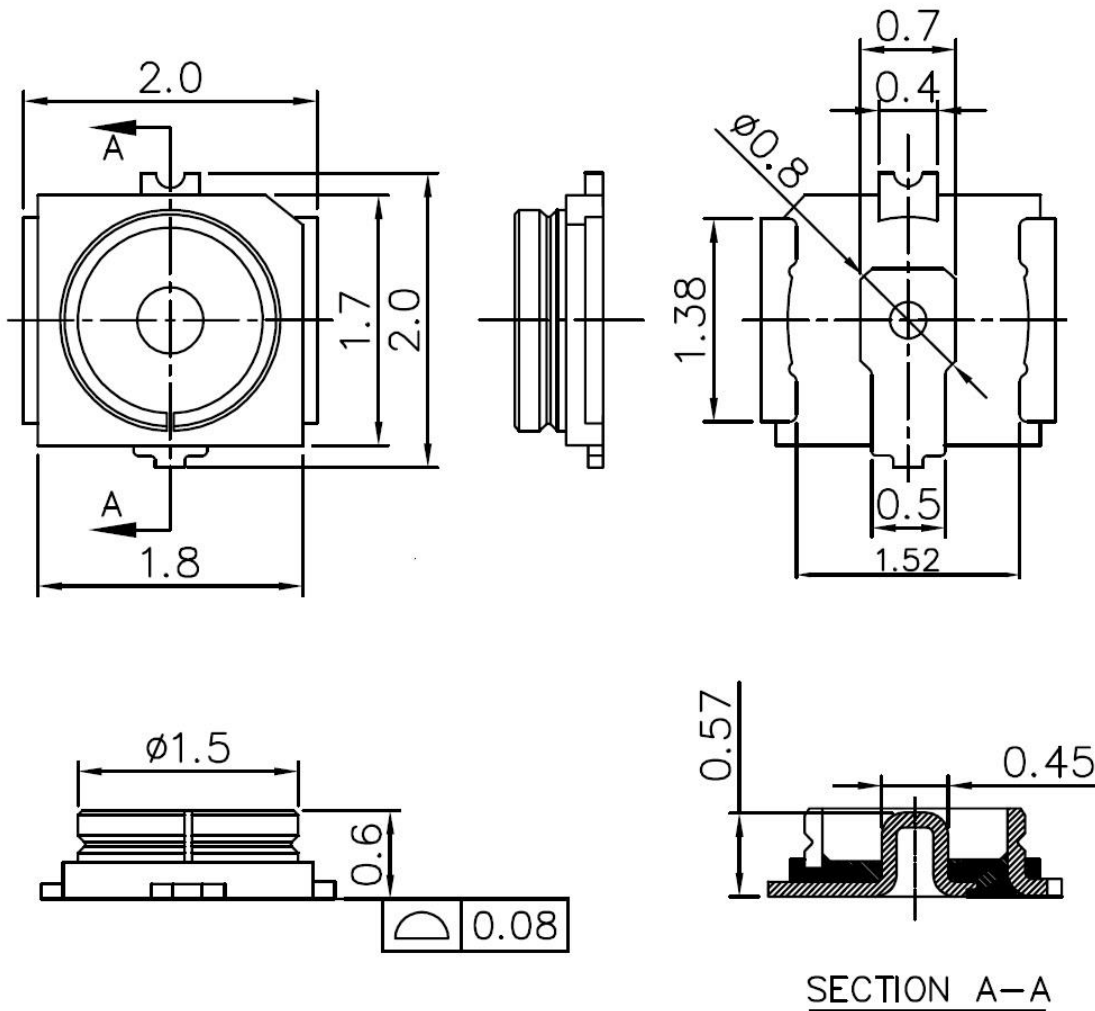


## 4.2. Pin out drawing



RECOMMENDED SOLDER PAD LAYOUT

### 4.3. Antenna connector drawing

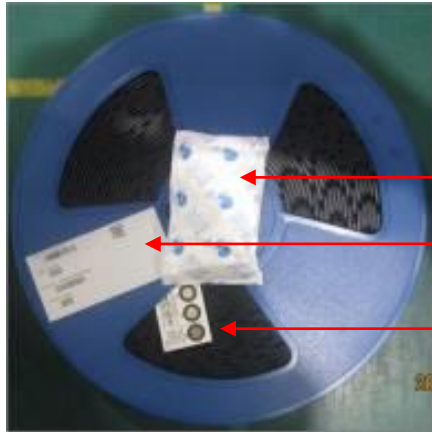


UNITS: mm



## 5. Packaging Information

### 5.1



1 UNIT DESICCANT

AFFIX PACKING LABEL

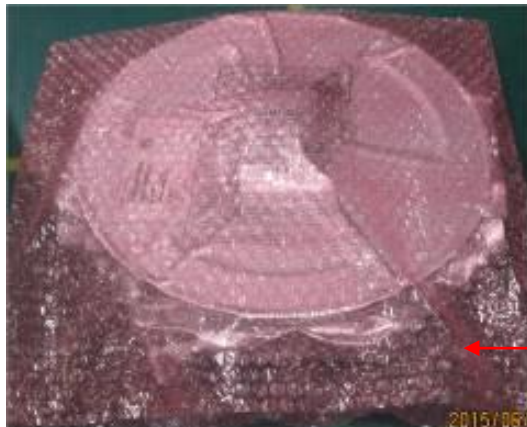
HUMIDITY INDICATOR CARD

### 5.2



AFFIX PACKING LABEL

### 5.3



PINK BUBBLE WRAP

**5.4**



AFFIX PACKING LABEL

**5.5**

1 Carton= 5 Boxes



**5.6**



**Note:** 1 tape reel = 1 box = 1,500pcs

**1 carton = 5 boxes = 5 \* 1,500pcs=7,500pcs**